

# 高速/全速USB 2.0开关

## 概述

MAX4906/MAX4906F/MAX4907/MAX4907F模拟开关具有较低的导通电容( $C_{ON}$ )和导通电阻( $R_{ON}$ )，能够满足系统对开关性能的严格要求。适合在480Mbps高速USB 2.0应用中提供高性能切换，这些开关可处理USB低速和全速信号。

MAX4906/MAX4906F具有两个单刀/双掷(SPDT)开关；MAX4907/MAX4907F具有两个单刀/单掷开关(SPST)。MAX4907/MAX4907F具有较低的 $7\Omega$  (最大值)导通电阻和 $7\text{pF}$ (最大值)导通电容。这些器件工作在+3.0V至+3.6V单电源，COM1和COM2具有+5.5V电压保护。这一特性完全符合USB 2.0的+5.5V故障保护规范。这些器件具有较低的逻辑门限电压， $V_{IH}$ 为+1.4V，支持低电压逻辑。MAX4906/MAX4906F/MAX4907/MAX4907F的静态工作电流为 $300\mu\text{A}$  (最大值)，关断功能将静态电流降低至 $2\mu\text{A}$  (最大值)以下。

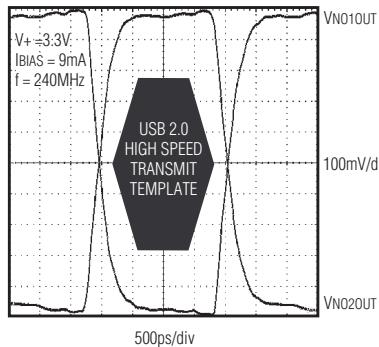
MAX4906/MAX4906F/MAX4907/MAX4907F采用节省空间的 $2\text{mm} \times 2\text{mm}$ 、 $\mu\text{DFN}$ 封装，工作在-40°C至+85°C温度范围。

## 应用

|         |             |
|---------|-------------|
| 蜂窝电话    | USB开关       |
| PDA     | 以太网交换机      |
| 数码相机    | 视频开关        |
| GPS     | 总线切换        |
| 笔记本电脑   | T3/E3冗余保护开关 |
| 继电器替代产品 |             |

## 典型工作特性

EYE DIAGRAM



## 特性

- ◆ 工作在+3.0V至+3.6V单电源
- ◆  $4\Omega$  (典型值)、 $7\Omega$  (最大值)导通电阻( $R_{ON}$ )
- ◆ MAX4907/MAX4907F具有低至 $4\text{pF}$  (典型值)、 $7\text{pF}$  (最大值)的导通电容( $C_{ON}$ )
- ◆ -3dB带宽为1GHz (典型值)
- ◆ 码间偏移 $\leq 100\text{ps}$
- ◆ 关断模式将功耗降至 $2\mu\text{A}$  (最大值)
- ◆ 兼容于3.3V、1.8V和1.4V逻辑
- ◆ COM\_具有模拟输入故障保护，防止与+5.5V USB电源短路时损坏器件
- ◆ 节省空间的封装

8引脚和10引脚、 $2\text{mm} \times 2\text{mm}$   $\mu\text{DFN}$ 封装

## 定购信息

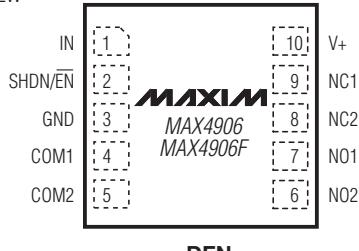
| PART               | PIN-PACKAGE        | PKG CODE |
|--------------------|--------------------|----------|
| <b>MAX4906ELB</b>  | 10 $\mu\text{DFN}$ | L1022-1  |
| <b>MAX4906FELB</b> | 10 $\mu\text{DFN}$ | L1022-1  |
| <b>MAX4907ELA</b>  | 8 $\mu\text{DFN}$  | L822-1   |
| <b>MAX4907FELA</b> | 8 $\mu\text{DFN}$  | L822-1   |

注：所有器件指定工作在-40°C至+85°C温度范围。

选型指南在数据资料的最后给出。

## 引脚配置

### TOP VIEW



$\mu\text{DFN}$

引脚配置(续)在数据资料的最后给出。

# 高速/全速USB 2.0开关

## ABSOLUTE MAXIMUM RATINGS

Voltages Referenced to GND

|   |                                  |
|---|----------------------------------|
| V <sub>+</sub>  | -0.3V to +4V                     |
| IN, SHDN, SHDN/EN (Note 1)  | -0.3V to (V <sub>+</sub> + 0.3V) |
| COM <sub>_</sub> , NO <sub>_</sub> , NC <sub>_</sub>  | -0.5V to +5.5V                   |
| Continuous Current (COM <sub>_</sub> to NO <sub>_</sub> /NC <sub>_</sub> )                              | ±120mA                           |
| Peak Current, (COM <sub>_</sub> to NO <sub>_</sub> /NC <sub>_</sub> )<br>(pulsed at 1ms 10% duty cycle) | ±240mA                           |

Continuous Power Dissipation (T<sub>A</sub> = +70°C)

|   |                 |
|---|-----------------|
| 8-Pin µDFN (derate 5.0mW/°C above +70°C)  | 400mW           |
| 10-Pin µDFN (derate 5.3mW/°C above +70°C) | 423.7mW         |
| Operating Temperature Range               | -40°C to +85°C  |
| Junction Temperature                      | +150°C          |
| Storage Temperature Range                 | -65°C to +150°C |
| Lead Temperature (soldering, 10s)         | +300°C          |

**Note 1:** Signals on IN, SHDN or SHDN/EN exceeding V<sub>+</sub> or GND are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

(V<sub>+</sub> = +3V to +3.6V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at V<sub>+</sub> = 3.3V, T<sub>A</sub> = +25°C.) (Note 2)

| PARAMETER                            | SYMBOL   | CONDITIONS  | MIN   | TYP            | MAX | UNITS |
|--------------------------------------|--|---|---|----------------|-----|-------|
| <b>ANALOG SWITCH</b>                 |  |   |   |                |     |       |
| Analog Signal Range                  | V <sub>COM<sub>_</sub></sub> , V <sub>NO<sub>_</sub></sub> , V <sub>NC<sub>_</sub></sub> | SHDN or SHDN/EN = 0 (Note 3)  | 0   | V <sub>+</sub> | V   |       |
| Fault-Protection Trip Threshold      | V <sub>FP</sub>  |   | 3.6   | 4.0            | 4.0 | V     |
| On-Resistance                        | R <sub>ON</sub>  | I <sub>COM<sub>_</sub></sub> = -40mA,<br>0V ≤ V <sub>COM<sub>_</sub></sub> ≤ V <sub>+</sub> ,<br>SHDN or SHDN/EN = 0                                      | T <sub>A</sub> = +25°C                                | 4              | 7   | Ω     |
|                                      |  |   | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> |                | 8   |       |
| On-Resistance During Shutdown        | R <sub>ONSH</sub>  | I <sub>COM<sub>_</sub></sub> = -40mA,<br>0V ≤ V <sub>COM<sub>_</sub></sub> ≤ 1.5V,<br>SHDN = V <sub>+</sub><br>(MAX4907/MAX4907F)                         | T <sub>A</sub> = +25°C                                | 4              | 10  | Ω     |
|                                      |  |   | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> |                | 13  |       |
| On-Resistance Match Between Channels | ΔR <sub>ON</sub>   | V <sub>+</sub> = 3.0V,<br>I <sub>COM<sub>_</sub></sub> = -40mA,<br>V <sub>COM<sub>_</sub></sub> = 1.5V (Note 4)   | T <sub>A</sub> = +25°C                                | 0.7            | 1.2 | Ω     |
|                                      |  |   | T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub> |                | 1.5 |       |
| On-Resistance Flatness               | R <sub>FLAT</sub> (ON)   | V <sub>+</sub> = 3.0V, I <sub>COM<sub>_</sub></sub> = -40mA,<br>V <sub>COM<sub>_</sub></sub> = 1.5V, 3.0V (Note 5)  |   | 1.0            |     | Ω     |
| Off-Leakage Current                  | I <sub>COM</sub> (OFF)   | V <sub>+</sub> = 3.6V, V <sub>COM<sub>_</sub></sub> = 0.3V, 3.3V;<br>V <sub>NO<sub>_</sub></sub> or V <sub>NC<sub>_</sub></sub> = 3.3V, 0.3V              |   | -1             | +1  | μA    |
| On-Leakage Current                   | I <sub>COM</sub> (ON)  | V <sub>+</sub> = 3.6V, V <sub>COM<sub>_</sub></sub> = 0.3V, 3.3V;<br>V <sub>NO<sub>_</sub></sub> or V <sub>NC<sub>_</sub></sub> = 0.3V, 3.3V, or floating |   | -1             | +1  | μA    |
| <b>SWITCH AC PERFORMANCE</b>         |  |   |   |                |     |       |
| On-Channel -3dB Bandwidth            | BW   | R <sub>L</sub> = R <sub>S</sub> = 50Ω, signal = 0dBm, Figure 1  | 1000  |                |     | MHz   |
| Off-Isolation                        | V <sub>ISO</sub>   | f = 10MHz; V <sub>NO<sub>_</sub></sub> , V <sub>NC<sub>_</sub></sub> = 1Vp-p;<br>R <sub>L</sub> = R <sub>S</sub> = 50Ω, Figure 1                          |   | -60            |     | dB    |
|                                      |  | f = 250MHz; V <sub>NO<sub>_</sub></sub> , V <sub>NC<sub>_</sub></sub> = 1Vp-p;<br>R <sub>L</sub> = R <sub>S</sub> = 50Ω, Figure 1                         |   | -32            |     |       |
|                                      |  | f = 500MHz; V <sub>NO<sub>_</sub></sub> , V <sub>NC<sub>_</sub></sub> = 1Vp-p;<br>R <sub>L</sub> = R <sub>S</sub> = 50Ω, Figure 1                         |   | -26            |     |       |

# 高速/全速USB 2.0开关

## ELECTRICAL CHARACTERISTICS (continued)

( $V_+ = +3V$  to  $+3.6V$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $V_+ = 3.3V$ ,  $T_A = +25^\circ C$ .) (Note 2)

| PARAMETER   | SYMBOL                              | CONDITIONS   |                            | MIN  | TYP | MAX   | UNITS |
|---|-------------------------------------|--|----------------------------|------|-----|-------|-------|
| Crosstalk (Note 6)                                | VCT                                 | $f = 10MHz$ ; $V_{NO\_}, V_{NC\_} = 1V_{P-P}$ ;<br>$R_L = R_S = 50\Omega$ , Figure 1   |                            | -59  |     | dB    |       |
|   |                                     | $f = 250MHz$ ; $V_{NO\_}, V_{NC\_} = 1V_{P-P}$ ;<br>$R_L = R_S = 50\Omega$ , Figure 1  |                            | -31  |     |       |       |
|   |                                     | $f = 500MHz$ ; $V_{NO\_}, V_{NC\_} = 1V_{P-P}$ ;<br>$R_L = R_S = 50\Omega$ , Figure 1  |                            | -25  |     |       |       |
| <b>SWITCH DYNAMICS</b>                            |                                     |  |                            |      |     |       |       |
| NO <sub>_</sub> , NC <sub>_</sub> Off-Capacitance | C(OFF)                              | $f = 1MHz$ , Figure 2 (Note 7)   |                            | 2    | 4   |       | pF    |
| Switch On-Capacitance                             | C(ON)                               | $f = 1MHz$ , Figure 2<br>(Note 7)  | MAX4906ELB,<br>MAX4906FELB | 6    | 9   | pF    |       |
|   |                                     |  | MAX4907ELA,<br>MAX4907FELA | 4    | 7   |       |       |
| Switch On-Capacitance Matching                    | CONM                                | $f = 1MHz$ (Note 7)  | MAX4906ELB,<br>MAX4906FELB | 0.4  |     | pF    |       |
|   |                                     |  | MAX4907ELA,<br>MAX4907FELA | 0.3  |     |       |       |
| Turn-On Time                                      | t <sub>ON</sub>                     | $V_{NO\_}, V_{NC\_} = 1.5V$ ; $R_L = 300\Omega$ , $C_L = 35pF$ ,<br>$V_{IH} = V_+$ , $V_{IL} = 0V$ , SHDN or SHDN/ $\overline{EN} = 0V$ ,<br>Figure 3                      |                            | 60   |     | ns    |       |
| Turn-Off Time                                     | t <sub>OFF</sub>                    | $V_{NO\_}, V_{NC\_} = 1.5V$ ; $R_L = 300\Omega$ , $C_L = 35pF$ ,<br>$V_{IH} = V_+$ , $V_{IL} = 0V$ , SHDN or SHDN/ $\overline{EN} = 0V$ ,<br>Figure 3; $T_A = +25^\circ C$ |                            | 30   |     | ns    |       |
| Propagation Delay                                 | t <sub>PLH</sub> , t <sub>PHL</sub> | $R_L = R_S = 50\Omega$ , Figure 4  |                            | 0.25 |     | ns    |       |
| Fault-Protection Response Time                    | t <sub>FP</sub>                     | $V_{COM\_} = 0$ to $5V$ step,<br>$R_L = R_S = 50\Omega$ , Figure 5   |                            | 3.0  |     | \mu s |       |
| Fault-Protection Recovery Time                    | t <sub>FPR</sub>                    | $V_{COM\_} = 5V$ to $3V$ step,<br>$R_L = R_S = 50\Omega$ , Figure 5  |                            | 2    |     | \mu s |       |
| Output Skew Between Switches                      | t <sub>SK(o)</sub>                  | Skew between switch 1 and switch 2, $R_L = R_S = 50\Omega$ , Figure 4 (Note 7)   |                            | 50   | 100 | ps    |       |
| Output Skew Same Switch                           | t <sub>SK(p)</sub>                  | Skew between opposite transitions in same<br>switch, $R_L = R_S = 50\Omega$ , Figure 4 (Note 7)  |                            | 50   | 100 | ps    |       |

# 高速/全速USB 2.0开关

## ELECTRICAL CHARACTERISTICS (continued)

( $V_+ = +3V$  to  $+3.6V$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $V_+ = 3.3V$ ,  $T_A = +25^{\circ}C$ .) (Note 2)

| PARAMETER                                | SYMBOL     | CONDITIONS  | MIN | TYP  | MAX | UNITS   |
|--|------------|---|-----|------|-----|---------|
| Total Harmonic Distortion Plus Noise     | THD+N      | $V_{COM\_} = 2V_{P-P}$ , $R_L = 600\Omega$ , $f = 20Hz$ to $20kHz$      |     | 0.03 |     | %       |
| Charge Injection                         | Q          | $V_{GEN} = 1.5V$ , $R_{GEN} = 0\Omega$ , $C_L = 100pF$ , Figure 6       |     | 5    |     | pC      |
| <b>SWITCH LOGIC</b>                      |            |   |     |      |     |         |
| Logic-Input-Voltage Low                  | $V_{IL}$   |   |     | 0.4  |     | V       |
| Logic-Input-Voltage High                 | $V_{IH}$   |   | 1.1 |      |     | V       |
| Input-Logic Hysteresis                   | $V_{HYST}$ |   | 100 |      |     | mV      |
| Input Leakage Current                    | $I_{IN}$   | $V_+ = 3.6V$ , $V_{IN} = 0$ or $V_+$                                    | -1  | +1   |     | $\mu A$ |
| Operating Supply-Voltage Range           | $V_+$      |   | 3.0 | 3.6  |     | V       |
| Quiescent Supply Current                 | $I_+$      | $V_+ = 3.6V$ , $V_{IN} = 0$ or $V_+$ , SHDN or SHDN/ $\bar{EN}$ = 0     | 120 | 300  |     | $\mu A$ |
| Quiescent Supply Current During Shutdown | $I_+$      | $V_+ = 3.6V$ , $V_{IN} = 0$ or $V_+$ , SHDN or SHDN/ $\bar{EN}$ = $V_+$ | 2   |      |     | $\mu A$ |

**Note 2:** All units are 100% production tested at  $T_A = +25^{\circ}C$ . Limits over the operating temperature range are guaranteed by design and not production tested.

**Note 3:** The switch will turn off for voltages above ( $V_{FP}$ ); therefore, protecting downstream circuits in case of a fault condition (MAX4906F/MAX4907F).

**Note 4:**  $\Delta R_{ON}(MAX) = |R_{ON(CH1)} - R_{ON(CH2)}|$

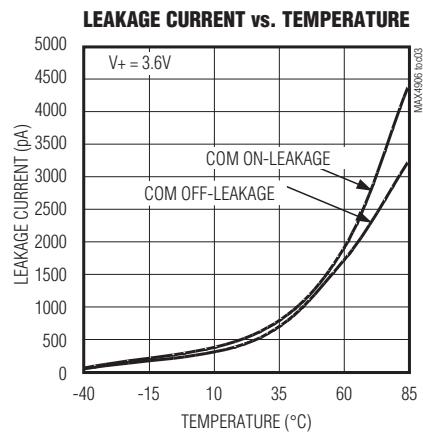
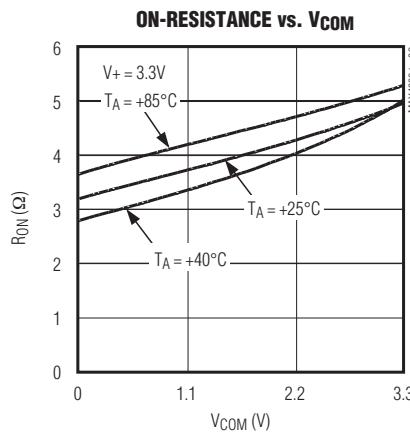
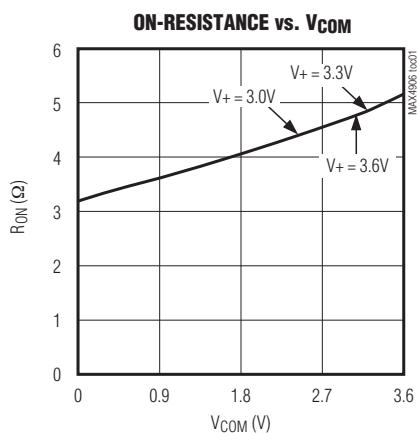
**Note 5:** Flatness is defined as the difference between the maximum and minimum value of on-resistance, as measured over specified analog signal ranges.

**Note 6:** Between any two switches.

**Note 7:** Switch off-capacitance, switch on-capacitance, output skew between switches, and output skew same-switch limits are not production tested; design guaranteed by bench characterization.

## 典型工作特性

( $T_A = +25^{\circ}C$ , unless otherwise noted.)

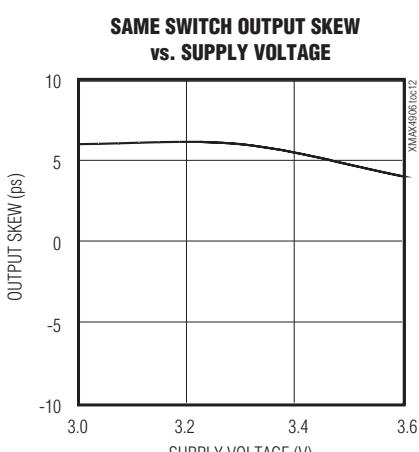
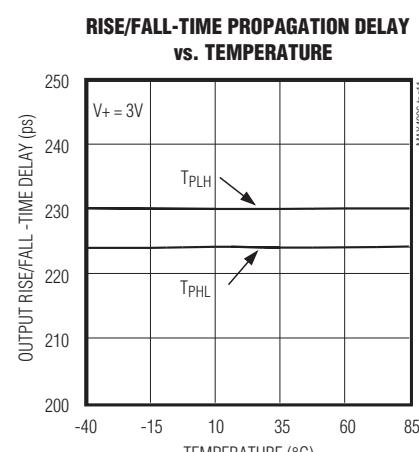
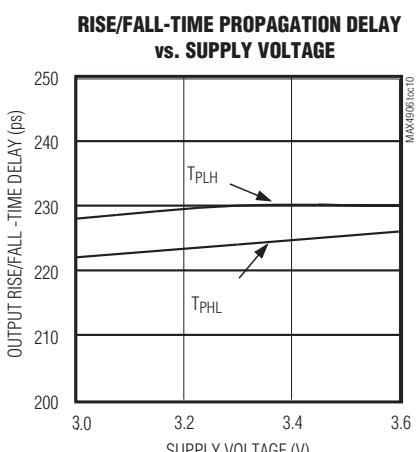
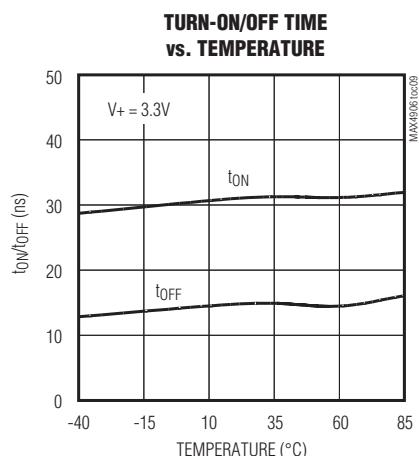
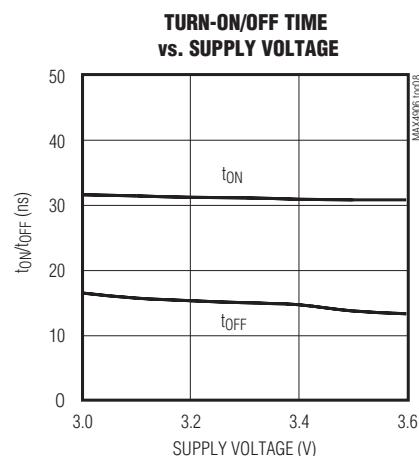
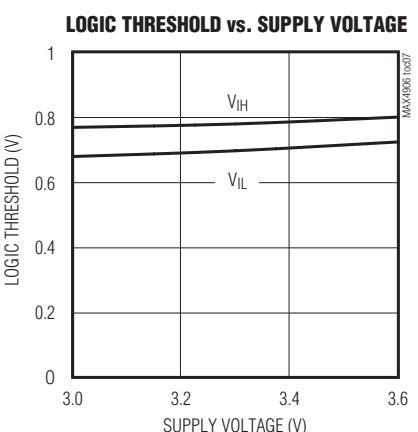
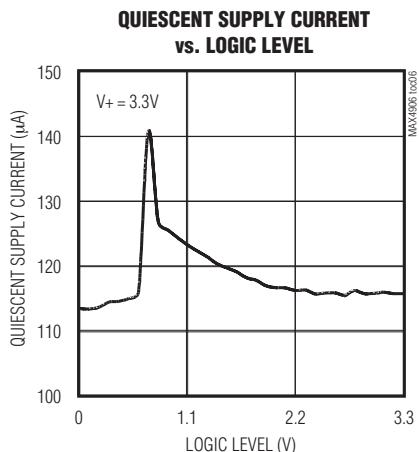
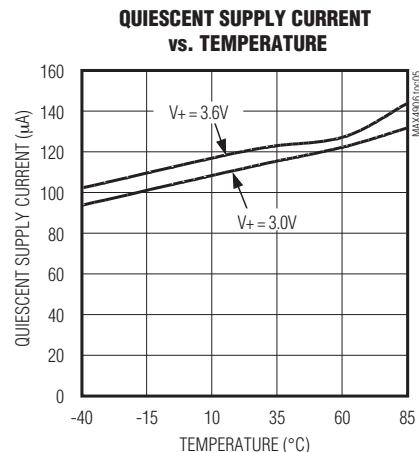
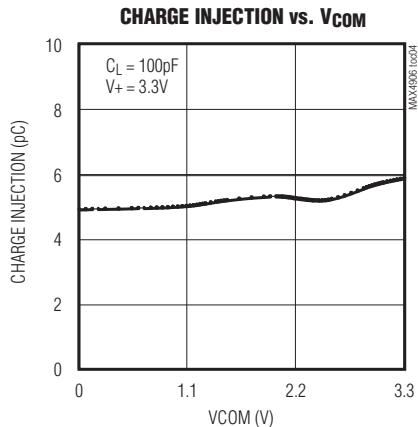


# 高速/全速USB 2.0开关

## 典型工作特性(续)

( $T_A = +25^\circ\text{C}$ , unless otherwise noted.)

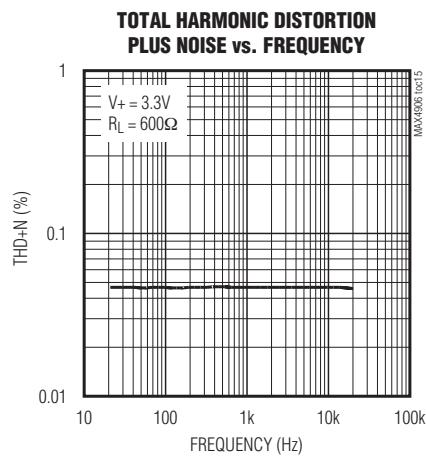
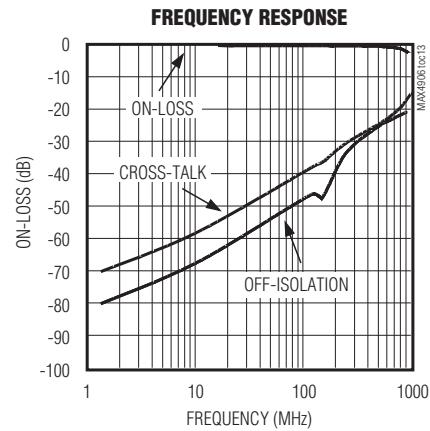
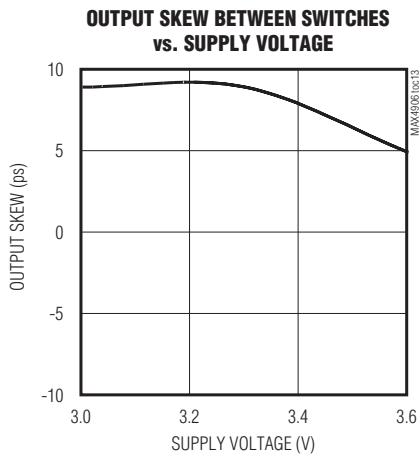
MAX4906/MAX4606F/MAX4907/MAX4907F



# 高速/全速USB 2.0开关

## 典型工作特性(续)

( $T_A = +25^\circ\text{C}$ , unless otherwise noted.)



# 高速/全速USB 2.0开关

## 引脚说明

| 引脚                   |                      | 名称      | 功能   |
|----------------------|----------------------|---------|--|
| MAX4906/<br>MAX4906F | MAX4907/<br>MAX4907F |         |  |
| 1                    | 8                    | IN      | 数字控制输入，IN控制开关1和开关2。  |
| 2                    | —                    | SHDN/EN | 关断和使能输入，驱动SHDN/EN至高电平时，电流损耗最小，器件处于高阻模式。在正常工作模式下，SHDN/EN为低电平。 |
| 3                    | 2                    | GND     | 地。   |
| 4                    | 3                    | COM1    | 模拟开关1—公共端。   |
| 5                    | 4                    | COM2    | 模拟开关2—公共端。   |
| 6                    | 5                    | NO2     | 模拟开关2—常开端。   |
| 7                    | 6                    | NO1     | 模拟开关1—常开端。   |
| 8                    | —                    | NC2     | 模拟开关2—常闭端。   |
| 9                    | —                    | NC1     | 模拟开关1—常闭端。   |
| 10                   | 7                    | V+      | 正电源输入，V+连接到3.0V至3.6V电源。采用一只0.1μF电容旁路V+至GND。                  |
| —                    | 1                    | SHDN    | 关断输入，驱动SHDN至高电平，器件进入关断模式。在正常工作模式下，SHDN为低电平。                  |

## 测试电路/时序图

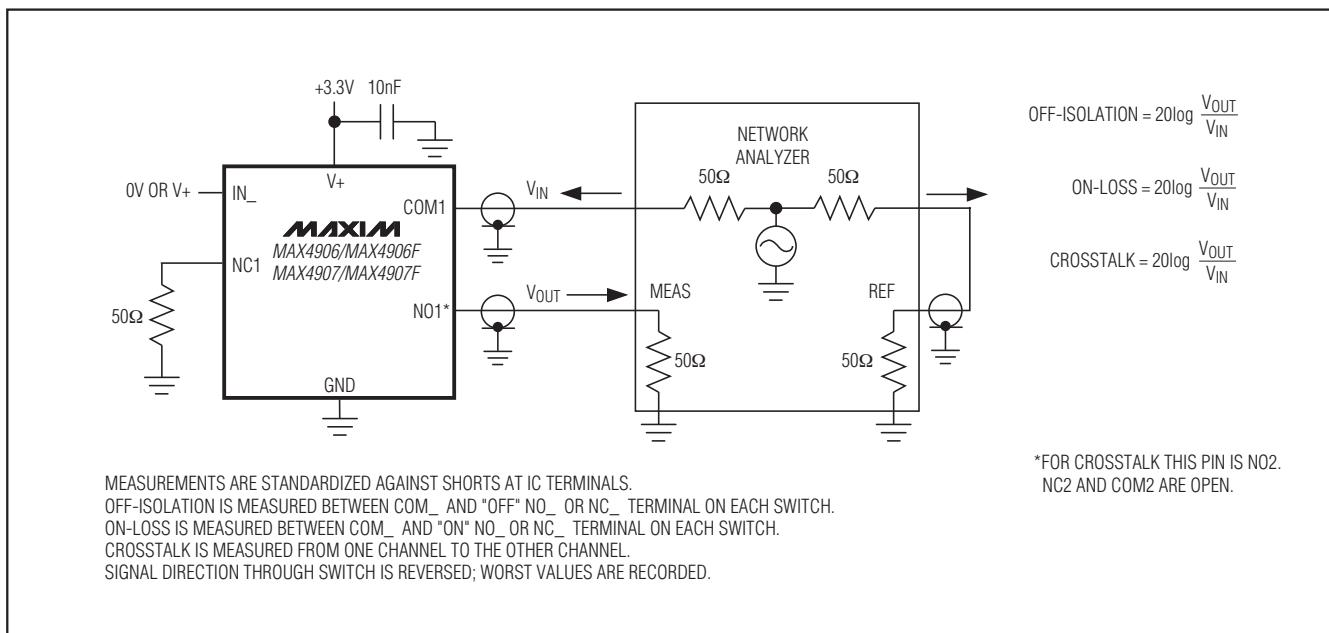


图1. 导通损耗、关断隔离和串扰

# 高速/全速USB 2.0开关

测试电路/时序图(续)

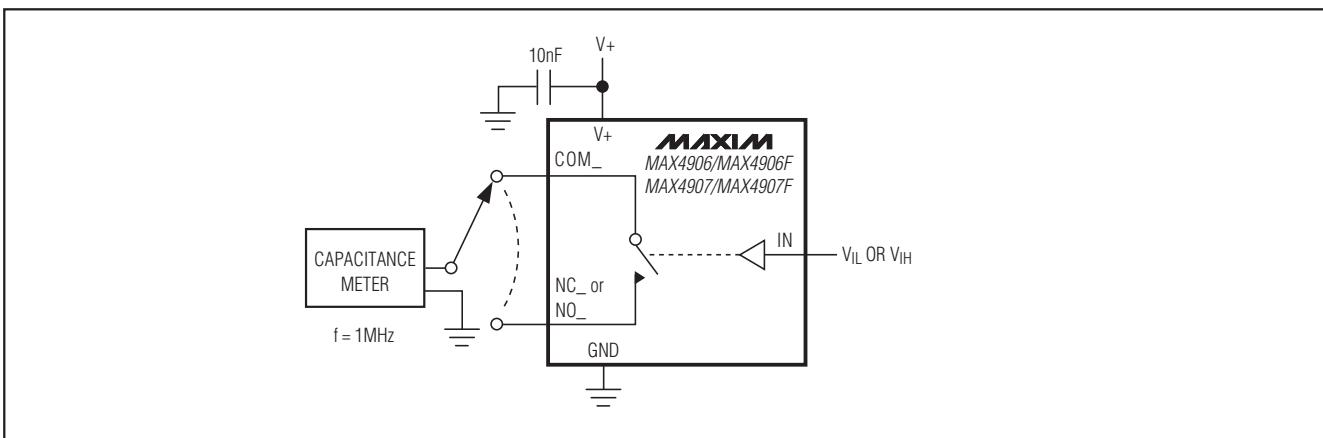


图2. 通道断开/导通电容

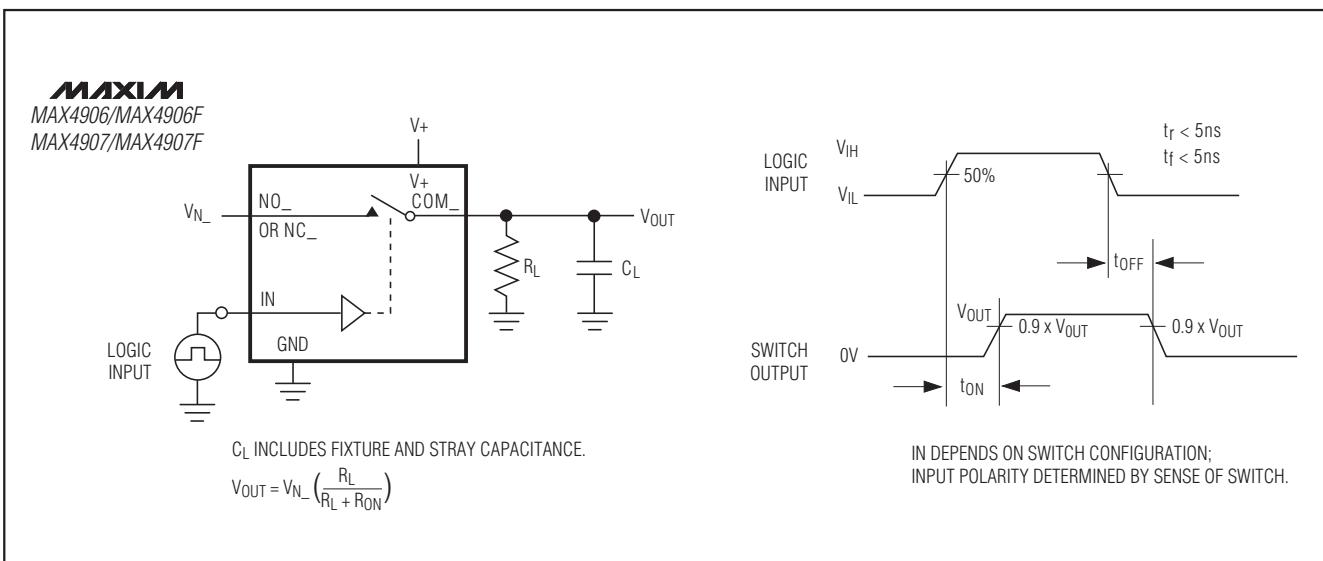


图3. 开关时间

# 高速/全速USB 2.0开关

测试电路/时序图(续)

MAX4906/MAX4906F/MAX4907/MAX4907F

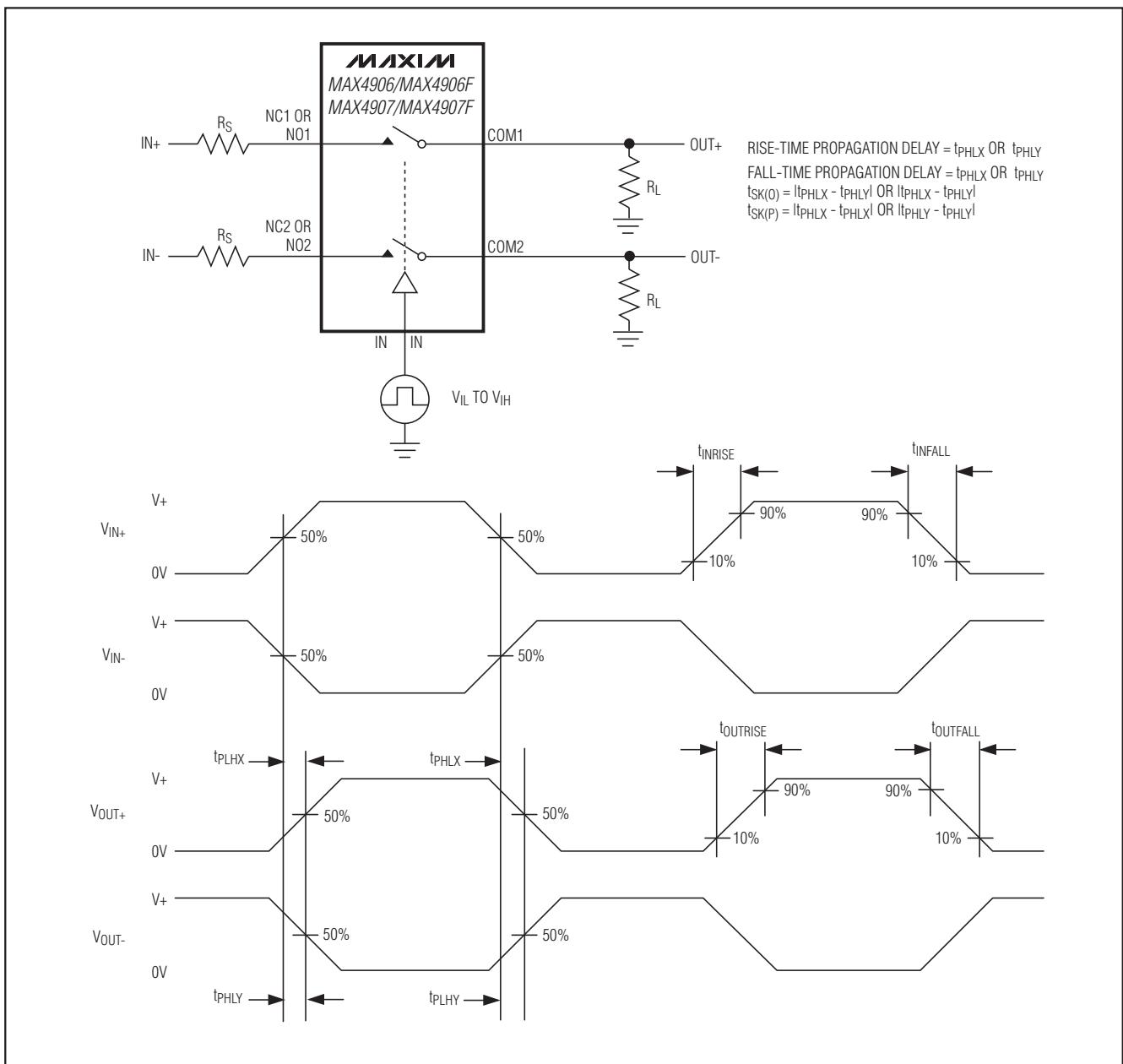


图4. 输出信号偏差、上升/下降时间、传输延迟

## 高速/全速USB 2.0开关

测试电路/时序图(续)

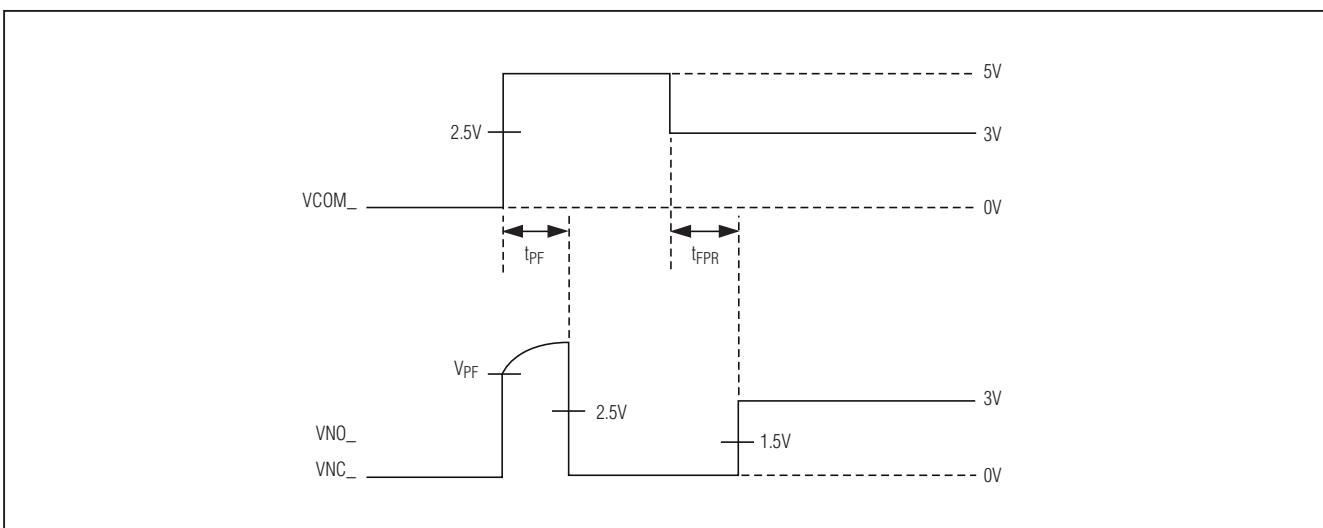


图5. MAX4906F/MAX4907F故障保护响应/恢复时间

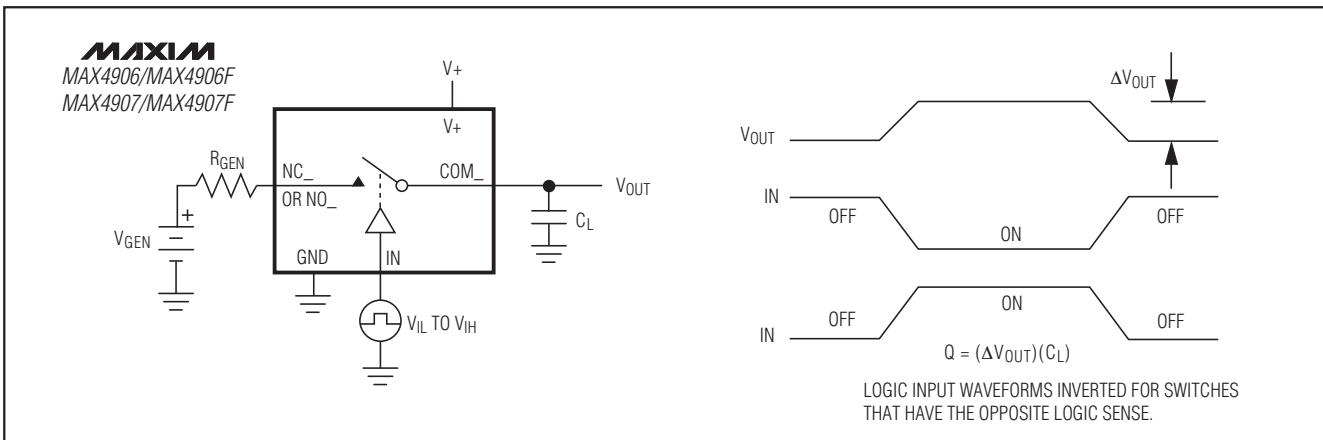


图6. 电荷注入

### 详细说明

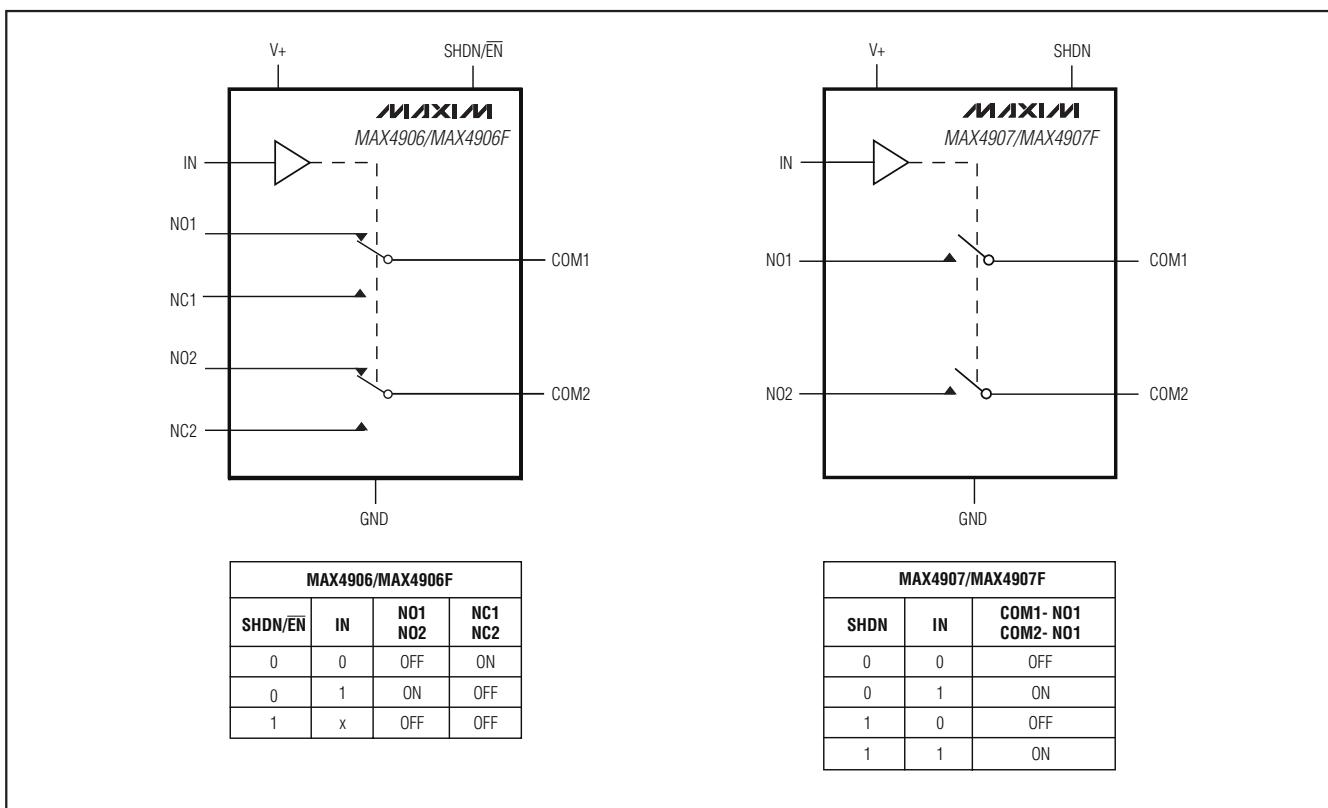
MAX4906/MAX4906F/MAX4907/MAX4907F模拟开关专为USB 2.0高速(480Mbps)开关应用设计。这些器件可满足USB低速和全速要求，非常适合10/100以太网开关。MAX4906/MAX4906F具有两个SPDT开关；而MAX4907/MAX4907F具有两个SPST开关。MAX4907/MAX4907F开关配置具有较低的7Ω(最大值)导通电阻和7pF(最大值)导通电容。MAX4906/MAX4906F/MAX4907/MAX4907F工作在

+3.0V至+3.6V单电源，并提供+5.5V故障保护(MAX4906F/MAX4907F)。当工作在+3.0V至+3.6V电源范围时，这些器件的门限电压支持低至1.4V的逻辑电平。MAX4906/MAX4906F/MAX4907/MAX4907F基于n沟道架构(由电荷泵驱动)，具有300μA(最大值)的静态工作电流。这些器件都带有关断输入，关断模式下使静态电流降低至2μA(最大值)以下。

# 高速/全速USB 2.0开关

功能框图/真值表

MAX4906/MAX4906F/MAX4907/MAX4907F



## 数字控制输入

MAX4906/MAX4906F/MAX4907/MAX4907F具有单数字控制逻辑输入(IN)。IN端控制开关位置，参见功能框图/真值表。满摆幅驱动IN可使功耗降至最低。采用+3.0V至+3.6V电源供电，这些器件兼容于+1.4V逻辑电平。

## 模拟信号电平

当模拟输入信号在地电位与V+之间变化时，MAX4906/MAX4906F/MAX4907/MAX4907F的导通电阻非常低，并且稳定(参见典型工作特性)。这些开关可双向工作，因此NO\_、NC\_和COM\_既可作为输入也可作为输出。

## 过压故障保护

MAX4906F和MAX4907F的COM1和COM2具有+5.5V故障保护，可防止开关与USB总线电源短路时损坏器件。

## 关断模式

MAX4906/MAX4906F具有关断模式，可将静态电流降低至 $2\mu A$ 以下。将SHDN/EN输入驱动至高电平时，器件处于高阻模式；SHDN/EN引脚为低电平时，器件正常工作。

MAX4907/MAX4907F具有SHDN输入，能够使静态电流降至 $2\mu A$ 以内。SHDN驱动至高电平时，器件处于低电流模式；器件可以工作在低电流模式，但模拟输入电压范围降至 $0 < V_{ANALOG} < 1.5V$ ，性能降低。当SHDN驱动至低电平时，MAX4907/MAX4907F处于正常工作模式。

## 应用信息

### USB开关

MAX4906/MAX4906F/MAX4907/MAX4907F模拟开关完全符合USB 2.0规范。这些开关具有较低的导通电阻和导通电

## 高速/全速USB 2.0开关

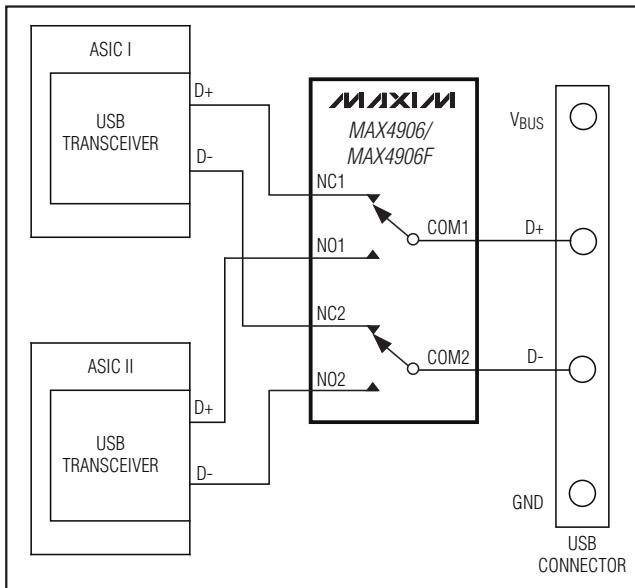


图7. MAX4906/MAX4906F用于USB数据线切换

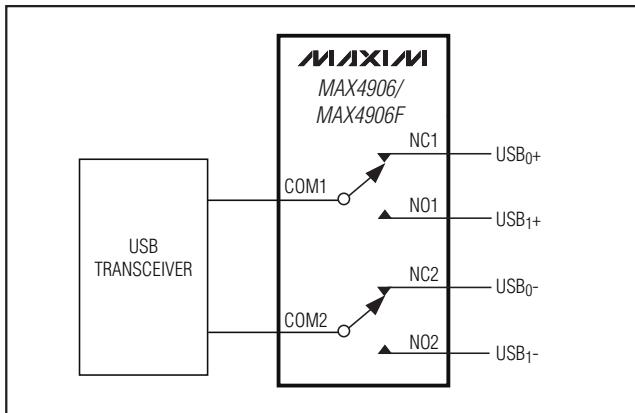


图8. MAX4906/MAX4906F用于多个USB主机之间的数据切换

容，使其非常适合高性能开关应用。MAX4906/MAX4906F可理想切换USB数据线(图7)以及多个USB主机之间数据切换(图8)。MAX4907/MAX4907F能够用于那些不同类型的数据共用同一引脚的系统(图9)；当然，共用引脚的器件一定具有三态模式。同时，MAX4906F/MAX4907F还具有+5.5V故障保护，防止系统与USB总线电源短路时损坏。对于USB应用，建议使用具有故障保护功能的器件。

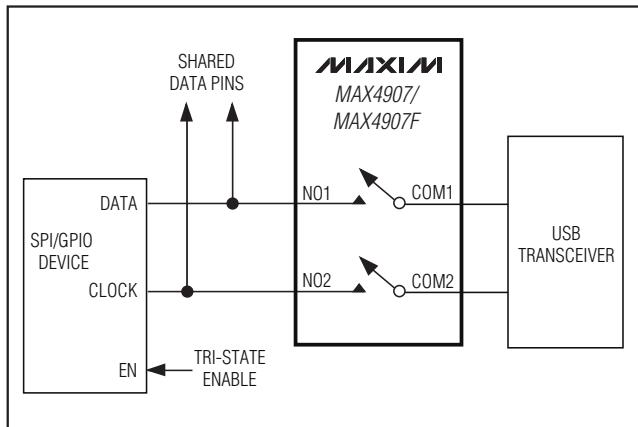


图9. MAX4907/MAX4907F USB/SPI/GPIO开关

### 以太网开关

MAX4906/MAX4906F/MAX4907/MAX4907F所具有的宽带特性可满足10/100以太网开关的需求。这些器件可用于切换来自两个接口变压器的信号，将信号连接到单个10/100 Base-T以太网PHY，从而简化了坞站设计，降低制造成本。

### 供电顺序

**警告：**不要超过器件的极限参数，一旦超出表中所列的极限参数将可能导致器件永久性损坏。

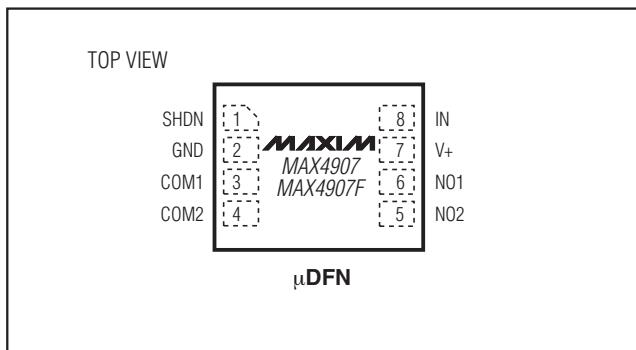
对于所有CMOS器件，推荐使用正确的供电顺序。总是在加模拟信号之前先加V<sub>+</sub>，尤其是在模拟信号没有限流的情况下。

### 电路板布局

高速开关要求正确的电路板布局和设计步骤，以获得最佳性能。要使阻抗受控的PCB引线尽可能短。确保旁路电容靠近器件安装，使用大面积接地层。

# 高速/全速USB 2.0开关

## 引脚配置(续)



## 选型指南

| PART        | CONFIGURATION | FAULT PROTECTION | TOP MARK |
|-------------|---------------|------------------|----------|
| MAX4906ELB  | Dual SPDT     | NO               | AAB      |
| MAX4906FELB | Dual SPDT     | YES              | AAA      |
| MAX4907ELA  | Dual SPST     | NO               | AAE      |
| MAX4907FELA | Dual SPST     | YES              | AAD      |

## 修订历史

Rev 2中的修改页: 1、2、3、7、11、14。

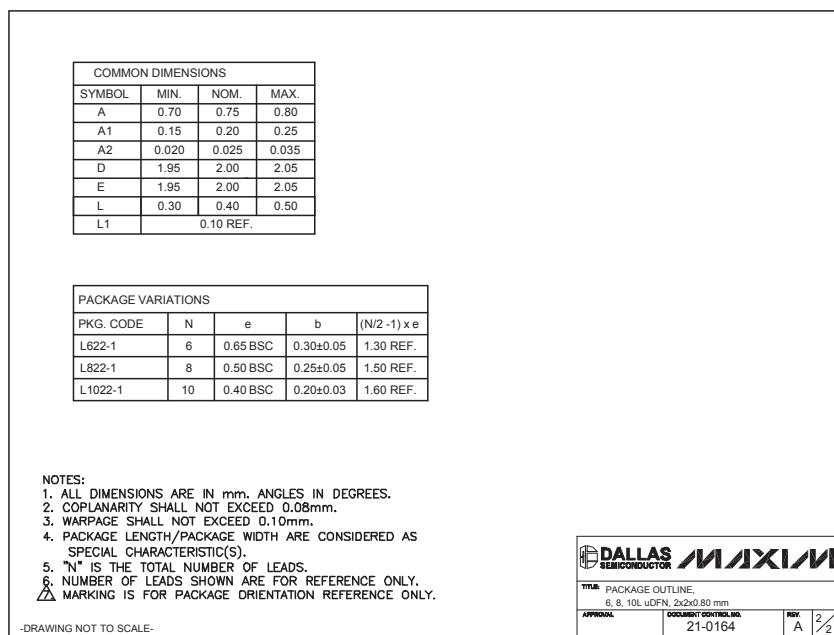
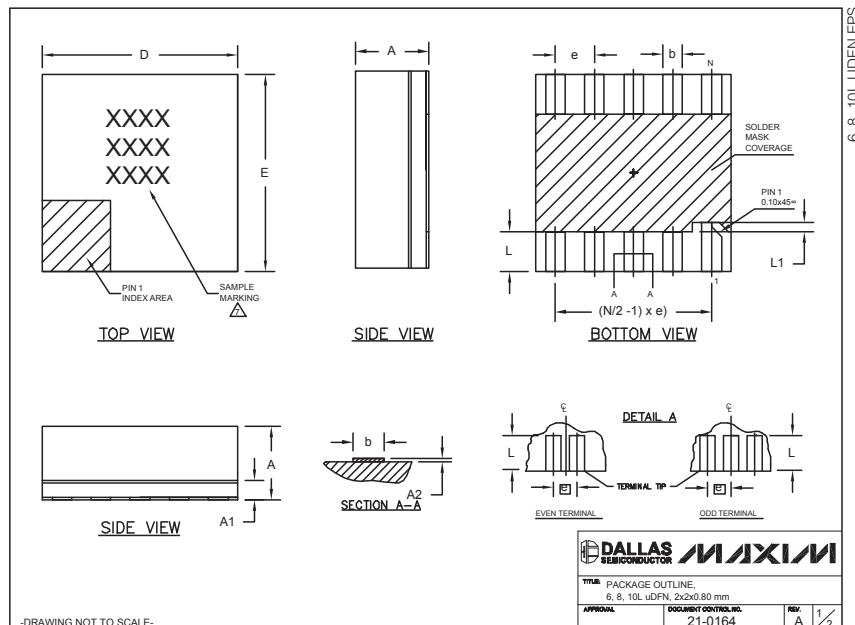
## 芯片信息

PROCESS: BiCMOS

# 高速/全速USB 2.0开关

## 封装信息

(本数据资料提供的封装图可能不是最近的规格, 如需最近的封装外形信息, 请查询 [www.maxim-ic.com.cn/packages](http://www.maxim-ic.com.cn/packages).)



Maxim不对Maxim产品以外的任何电路使用负责, 也不提供其专利许可。Maxim保留在任何时间、没有任何通报的前提下修改产品资料和规格的权利。